

(The English Partial translation of Japanese Patent Publication No. 59-109528)

- (19) The Japanese Patent Office
- (12) Patent Publication
- (11) Patent Publication No. 59-109528
- (43) Publication date: June 25, 1984
- (54) entitled: COATED POLYCARBONATE-BASED RESIN MOLDED ARTICLE
- (21) Japanese Patent Application No. 57-221664
- (22) Filing date: December 16, 1982
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(From line 5 from the bottom, right lower column of page 3 to line 3 from the bottom, right lower column of page 4)

The silicon compounds having an epoxy group, for use as Component (A) in the present invention, represented by the general formula (1) include the following silicon compounds. Specific examples of the compound having one glycidoxy group include glycidoxymethyltrimethoxysilane, glycidoxymethyltriethoxysilane,  $\beta$ -glycidoxyethyltrimethoxysilane,  $\beta$ -glycidoxyethyltriethoxysilane,  $\gamma$ -glycidoxypropyltrimethoxysilane,  $\gamma$ -glycidoxypropyltri(methoxyethoxy)silane,  $\gamma$ -glycidoxypropyltriacetoxysilane,  $\delta$ -glycidoxybutyltrimethoxysilane,  $\delta$ -glycidoxybutyltriethoxysilane, glycidoxymethyldimethoxysilane, glycidoxymethyl(methyl)dimethoxysilane, glycidoxymethyl(ethyl)dimethoxysilane, glycidoxymethyl(phenyl)dimethoxysilane, glycidoxymethyl(vinyl)dimethoxysilane, glycidoxymethyl(dimethyl)methoxysilane,  $\beta$ -glycidoxyethyl(methyl)dimethoxysilane,  $\beta$ -glycidoxyethyl(ethyl)dimethoxysilane,  $\beta$ -glycidoxyethyl(dimethyl)methoxysilane,  $\gamma$ -glycidoxypropyl(methyl)dimethoxysilane,  $\gamma$ -glycidoxypropyl(ethyl)dimethoxysilane,  $\gamma$ -glycidoxypropyl(dimethyl)methoxysilane,  $\delta$ -glycidoxybutyl(methyl)dimethoxysilane,

$\delta$ -glycidoxybutyl(ethyl)dimethoxysilane and  
 $\delta$ -glycidoxybutyl(dimethyl)methoxysilane. Specific examples of  
the compound having 2 or 3 glycidoxy groups include  
bis(glycidoxymethyl)dimethoxysilane,  
bis(glycidoxymethyl)diethoxysilane,  
bis(glycidoxyethyl)dimethoxysilane,  
bis(glycidoxyethyl)diethoxysilane,  
bis(glycidoxypropyl)dimethoxysilane,  
bis(glycidoxypropyl)diethoxysilane,  
tris(glycidoxymethyl)methoxysilane,  
tris(glycidoxymethyl)ethoxysilane,  
tris(glycidoxyethyl)methoxysilane,  
tris(glycidoxyethyl)ethoxysilane,  
tris(glycidoxypropyl)methoxysilane and  
tris(glycidoxypropyl)ethoxysilane. Specific examples of the  
compound having a glycidyl group include  
glycidylmethyltrimethoxysilane, glycidylmethyltriethoxysilane,  
 $\beta$ -glycidylethyltrimethoxysilane,  $\beta$ -glycidylethyltriethoxysilane,  
 $\gamma$ -glycidylpropyltrimethoxysilane,  
 $\gamma$ -glycidylpropyltriethoxysilane,  
 $\gamma$ -glycidylpropyltri(methoxyethoxy)silane and  
 $\gamma$ -glycidylpropyltriacetoxysilane. Specific examples of the  
compound having an alicyclic epoxy group include  
3,4-epoxycyclohexylmethyltrimethoxysilane,  
3,4-epoxycyclohexylmethyltriethoxysilane,  
3,4-epoxycyclohexylethyltrimethoxysilane,  
3,4-epoxycyclohexylpropyltrimethoxysilane and  
3,4-epoxycyclohexylbutyltrimethoxysilane.

The organic silicon compounds of the general formula (2) for  
use as Component (B) in the present invention are as follows. That  
is, they include trimethylmethoxysilane, dimethyldimethoxysilane,  
methyltrimethoxysilane, tetraethoxysilane,  
phenyltrimethoxysilane, phenylmethyldimethoxysilane,  
vinyltriethoxysilane, vinyltris( $\beta$ -methoxyethoxy)silane,  
vinyltriacetoxysilane,  $\gamma$ -methacryloxypropyltrimethoxysilane,  
 $\gamma$ -aminopropyltriethoxysilane,  
N-( $\beta$ -aminoethyl)- $\gamma$ -aminopropyltrimethoxysilane,  
N-bis( $\beta$ -hydroxyethyl)- $\gamma$ -aminopropyltriethoxysilane,

N-( $\beta$ -aminoethyl)- $\gamma$ -aminopropyl(methyl)dimethoxysilane,  
 $\gamma$ -chloropropyltrimethoxysilane,  $\gamma$ -mercaptopropyltrimethoxysilane  
and 3,3,3-trifluoropropyltrimethoxysilane. These may be used alone  
or two or more of them may be used in combination.